

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	10/059907	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:17
S4	2	"6368475".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/15 15:19
S5	3	("4391694" "5904827" "6126798").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/15 15:24
S7	32574	("204" "205").clas. and (electroplating or plating or processing)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:54
S8	8782	S7 and (wafer or semiconductor or microelectronic)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/15 15:25
S9	93	S8 and diffuser and membrane	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/15 16:23
S10	819	S8 and diffus\$4 and membrane	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/15 15:26
S11	8	S8 and diffuser and membrane and pressure adj drop	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/15 16:23
S12	17	S8 and diffuser and membrane and pressure adj (drop or differen\$4)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 14:51
S13	1	"6258220".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 13:07
S14	2042	applied material and seal and (filter or diffus\$4)	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 13:08
S15	446	S14 and (electroplating or plating or (electrochemical processing))	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 13:09
S16	391	S15 and (semiconductor or wafer or workpiece)	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 13:09

S17	154393	electroplating or plating or (electrochemical adj processing)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 14:51
S18	47947	S17 and (semiconductor or wafer or microelectronic\$2)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 14:52
S19	229	S18 and (distribut\$4 or diffus\$4) and seal\$4 and membrane and conical	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:10
S20	204	S18 and ((distribut\$4 or diffus\$4) or membrane) same conical	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:55
S21	152	S20 not S19	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:11
S23	19960	("204" "205").clas. and (electroplating or plating)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:59
S24	126	S23 and ((distribut\$4 or diffus\$4) or membrane) same conical	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:01
S25	71	S24 not (S19 or S20)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 15:56
S26	5023	("204" "205").clas. and (semiconductor or wafer or workpiece) and (plating or electroplating)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:01
S27	61	S26 and ((distribut\$4 or diffus\$4) or membrane) same conical	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:08
S28	531	S26 and ((distribut\$4 or diffus\$4) and membrane)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:12
S30	68	S28 and pressure adj (drop or differen\$5)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:17
S31	1	"6527920".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:17
S32	20	("6126798").URPN.	USPAT	OR	ON	2005/11/16 16:34
S33	1	"6261426".pn.	USPAT	OR	ON	2005/11/16 16:34

S34	51	("3962047" "4137867" "4170959" "4246088" "4259166" "4280882" "4304641" "4339297" "4341613" "4466864" "4469566" "4534832" "4565607" "4597836" "4696729" "4828654" "4861452" "4879007" "4906346" "4931149" "5000827" "5024746" "5078852" "5096550" "5135636" "5222310" "5227041" "5332487" "5372699" "5377708" "5391285" "5405518" "5421987" "5429733" "5437777" "5441629" "5443707" "5447615" "5462649" "5472592" "5498325" "5522975" "5597460" "5670034" "5725745" "5750014" "5776327" "5788829" "5804052" "5843296" "5855850").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 16:37
S35	201	S26 and ((distribut\$4 or diffus\$4) same seal)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:46
S36	1	"6416647".pn.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:17
S37	4	09/351864	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:45
S38	165	S35 not semitool.as.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:46
S39	137	S38 not (applied materials).as.	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 18:02
S40	1	"6402923".pn.	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 17:58
S41	7	("3437578" "4469566" "5804052" "6033540" "6132805" "6179983").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 17:59
S42	4	("20020000380" "20020008037" "6193860" "6497801").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/16 18:01

S43	776	(steven near2 mayer) or (Novellus Systems)	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 18:03
S44	227	S43 and plating	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 18:03
S45	275	S43 and (plating or electroplating) and (semiconductor or wafer)	US-PGPUB; USPAT; USOCR	ADJ	ON	2005/11/16 18:14
S47	18138	(plating or electroplating) and (semiconductor or wafer or workpiece or microelectronic\$2)	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:14
S48	1154	S47 and (diffus\$4 or distribut\$4)	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:21
S49	60	S48 and seal\$4	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:18
S50	10	S48 and membrane	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:18
S51	10	S47 and diffuser	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:19
S52	795	S47 and diffus\$4	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:22
S53	0	S47 and diffus\$4 near4 porous	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:22
S54	182	S47 and membrane	EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2005/11/16 18:22
S55	154579	electroplating or plating or (electrochemical adj processing)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:02
S56	48040	S55 and (semiconductor or wafer or microelectronic\$2)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:02
S57	229	S56 and (distribut\$4 or diffus\$4) and seal\$4 and membrane and conical	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:03
S58	1927	S56 and (distribut\$4 or diffus\$4) same seal\$4	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:04
S60	107	S58 and diffuser	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:05

S61	114	S58 and (diffuser or (diffusion adj member))	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:30
S62	396	S58 and baffle	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:34
S63	35	S58 and baffle same seal	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:30
S65	35	S58 and baffle same (seal or shield)	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:31
S66	18	S62 and ("204" "205").clas.	US-PGPUB; USPAT; USOCR	OR	ON	2005/11/17 10:34
S67	4	("6442997" "6251251").pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 11:10
S68	193	cyprian near2 uzoh	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 11:11
S69	99	cyprian near2 uzoh	USPAT	OR	ON	2005/11/17 11:20
S71	19	S69 and (filter or membrane)	USPAT	OR	ON	2005/11/17 11:23
S73	2	"6126798".pn.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/11/17 11:41